DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

As a below named inventor, I hereby declare that: My residence, mailing address, and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

LAMINATED RESIN FORMED BODY, METHOD FOR PRODUCING LAMINATED RESIN FORMED BODY, **AND MULTILAYER ARTICLE**

| the application of which ☑ is attached hereto | OR | ☐ was filed on June PCT International A and was amended on | pplication Numl | ber PCT/JP2004/003 | 8452 |
|--|---|---|---|--|---|
| I hereby state that I have reviewed and by any amendment specifically referred | understand the cor to above. | ntents of the above ident | tified application | , including the clain | ns, as amended |
| I acknowledge the duty to disclose continuation-in-part application(s), mat the national or PCT international filing | erial information w | hich became available | between the filin | ed in 37 CFR 1.56, ag date of the prior a | including for application and |
| I hereby claim foreign priority under 35 breeder's rights certificate(s), or 365(a) United States of America, listed below inventor's or plant breeder's rights cerapplication on which priority is claimed | of any PCT intern and have also ide tificate(s), or any | ational application(s) wentified below, by check | hich designated cing the box, an | at least one country y foreign application | other than the n(s) for patent. |
| Prior Application Number(s) | Country | v F: | ling Date | Priority Cl | |
| 2003-172257 | JP | | ne 17, 2003 | Yes ☑ | No 🗆 |
| I hereby claim benefit under 35 United S | States Code §119(e |) of any United States p | rovisional applic | ation(s) listed below | <i>t</i> . |
| | Application Number(s) | | Filing Date | | |
| I hereby claim benefit under 35 United application(s) designating the United St not disclosed in a listed prior United Sta United States Code, §112, I acknowled defined in 37 C.F.R. 1.56 which occurred to of this applications. | ates, listed below a ites or PCT Internating Ige my duty to dis | nd, insofar as the subjectional application in the sclose any information | et matter of each manner provided material to the | of the claims of this d by the first paragra patentability of this | s application is ph of Title 35, application as |
| date of this application: | | | | | |
| Prior U.S. or International Application No | ımber(s) | U.S. or International Filin | ng Date | Status | 3 |

prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith, recognizing that the specific attorneys listed under that Customer Number may be changed from time to time at the sole discretion of Sughrue Mion, PLLC, and request that all correspondence about the application be addressed to the address filed under the same USPTO Customer Number.

washington office 23373

CUSTOMER NUMBER

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| Given Name | | | | | |
|-------------------------------------|---------------------|---------------------------------|------------------------------|--|--|
| (first and middle [if any]) Takeshi | | Family Name or Surna | Family Name or Surname INABA | | |
| Inventor's Signature Takes | i Imaba | | Date July 6. 2004 | | |
| Residence: City Settsu-shi | State Osaka | Country Japan | Citizenship Japan | | |
| Mailing Address: c/o DAIKIN INI | OUSTRIES, LTD., You | logawa Plant, 1-1, Nishihitotsu | ıya, | | |
| City Settsu-shi | State Osaka | Zip 566-8585 | Country Japan | | |